

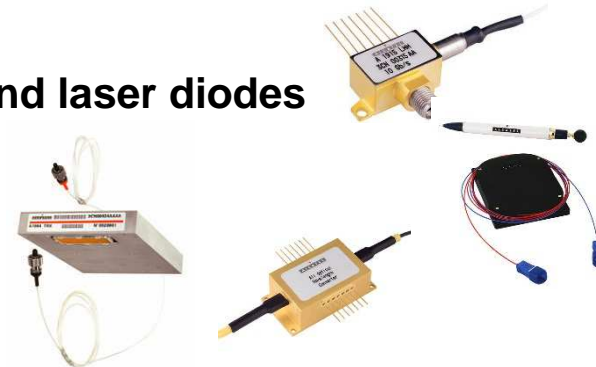
Part 2

Optoelectronic Components

◆ Optical components and product families

• Active optical components

- Light sources : light emitting diodes and laser diodes
- Detectors and optical receivers
- Optical amplifiers
- Components for the optical routing



• Passive optical components

- The FBG technology
- Components realized using the FBG technology
- The AWG technology and associated components
- Optical connectors

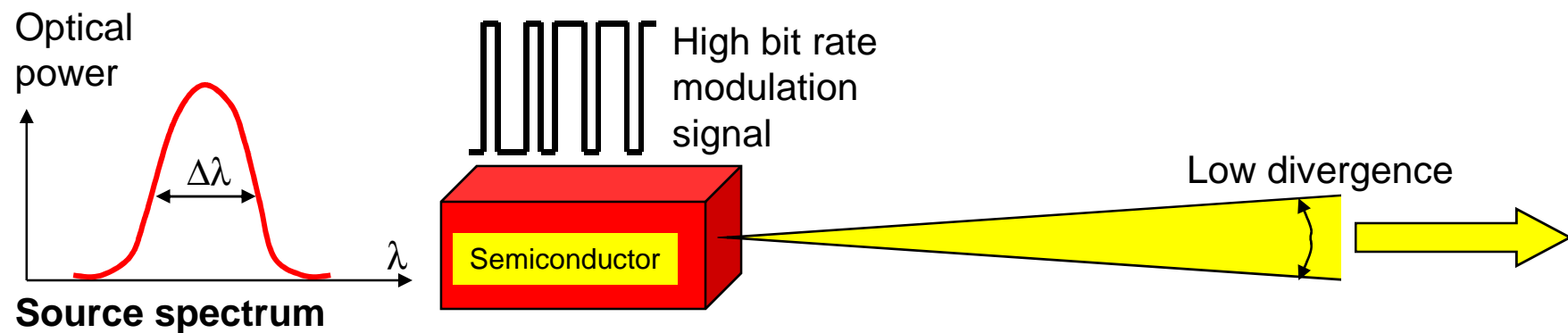




Light sources (1)

♦ Main characteristics required

- Semiconductor source (compact and easy to implement)
- High emitted optical power
- Low divergence beam for better coupling efficiency to fiber
- Narrow spectral width for reducing chromatic dispersion and for dense WDM application
- Possibility of high bit rate modulation





Light sources (2)

♦ Two possible candidates

- LED (light emitting diode)
- LD (laser diode)

♦ The light emitting diode (LED) : not performant enough



- Low emitted power (some tens microwatts μW)
- Too high beam divergence thus bad coupling efficiency to fiber
- Broad spectral width (some tens nm)

♦ The laser diode (LD) : the best appropriate source

- High emitted power (some tens milliwatts mW)
- Very low beam divergence (high coupling efficiency to a singlemode fiber)
- Very narrow spectral width, well matched to WDM systems





Light sources (3)

♦ The optical power of a source

- Explained either in milliwatts (mW), or in dBm (dB reported to 1mW)
- $\text{Power (dBm)} = 10 \log \text{Power (mW)}$

Power in mW	Power in dBm
1 mW	0 dBm
2 mW	+ 3 dBm
4 mW	+ 6 dBm
10 mW	+ 10 dBm
100 mW	+ 20 dBm
Multiply by 2	Add 3 dBm
Divide by 2	Subtract 3 dBm
Multiply by 10	Add 10 dBm
Divide by 10	Subtract 10 dBm

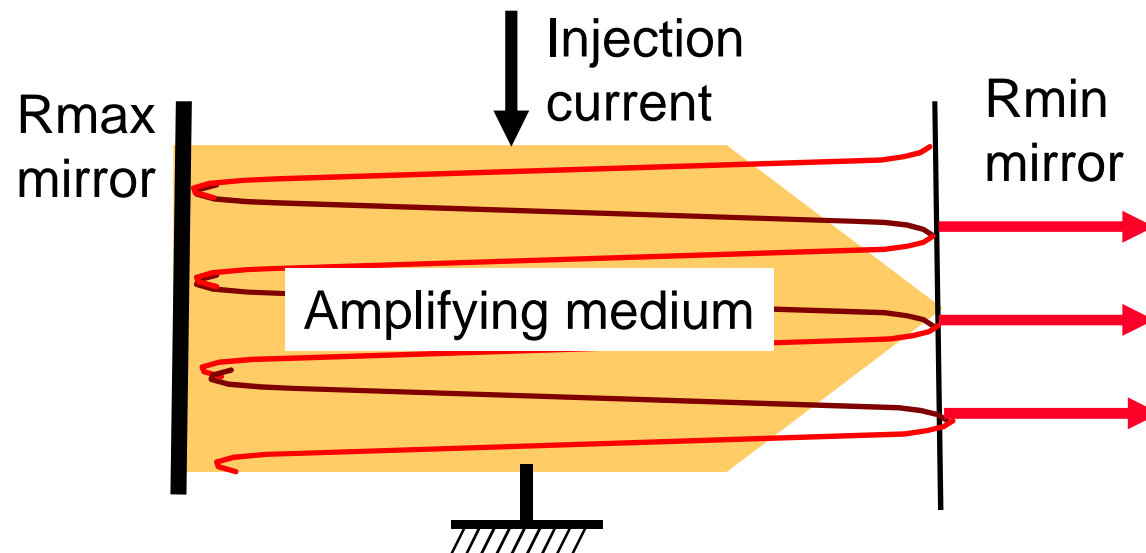
Examples :

+ 23 dBm
 = +20 dBm +3 dBm
 = $100 \times 2 = 200 \text{ mW}$

- 26 dBm
 = -20 dBm - 6 dBm
 = $1/100 \times 1/4 \text{ mW}$
 = $0.01 \times 0.25 \text{ mW}$
 = 0.0025 mW
 = $2.5 \mu\text{W}$

Laser diodes (1)

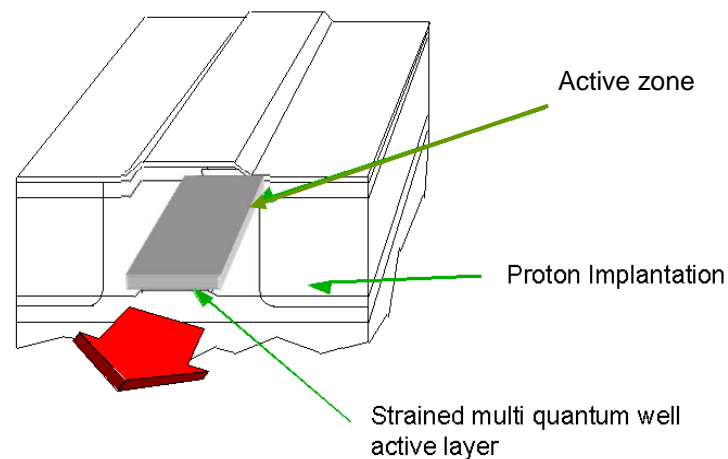
- ♦ **LASER = Light Amplification by Stimulated Emission of Radiation**
- ♦ **Laser = amplifying medium in a resonant cavity (Fabry-Perot)**
- ♦ **Semiconductor laser (or laser diode)**
 - Amplifying medium : diode type junction
 - Pumping technique : injection current
 - Resonant cavity : cleaved facets of the laser chip



♦ Two categories of laser diodes (1)

- FP : Fabry-Perot type laser diode

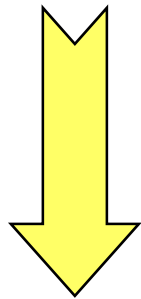
- The most simple structure
- Broad spectrum (multiple rays) => limitation due to chromatic dispersion
- Used for short distance links
- Not appropriate for wavelength division multiplexing (WDM)



Single channel
Low bit rate
Short distance

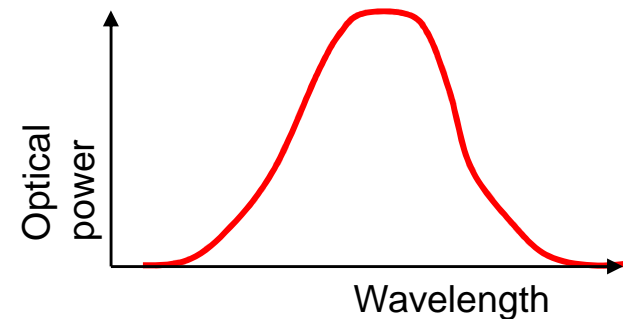
Laser diodes (3)

**Fabry-Perot
laser diode
spectrum**

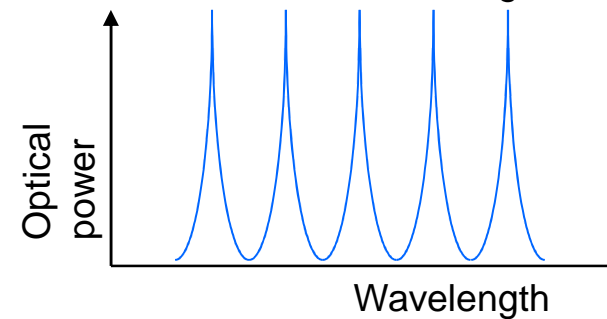


**Single channel
Low bit rate
Short distance**

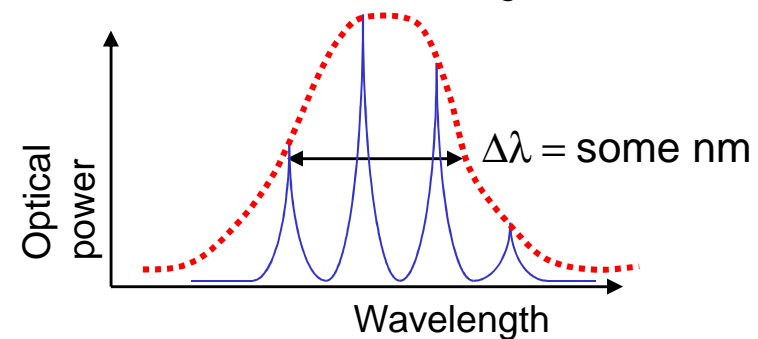
Active material
gain curve



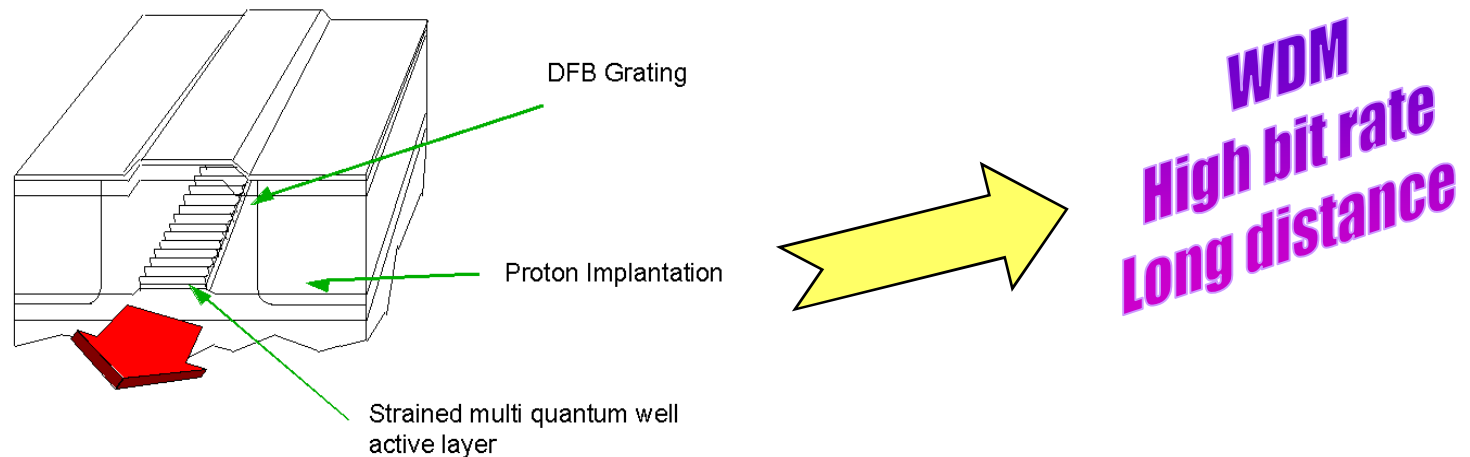
Fabry-Perot cavity
spectrum (comb)



Fabry-Perot
laser diode
spectrum

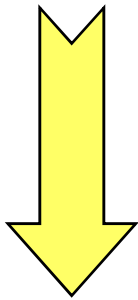


- ♦ Two categories of laser diodes (2)
 - DFB : Distributed Feed-Back laser diode
 - More complex structure (integrated diffraction grating)
 - Narrow spectrum (single longitudinal mode) ==> very low chromatic dispersion
 - Well suited to long haul links and to WDM systems



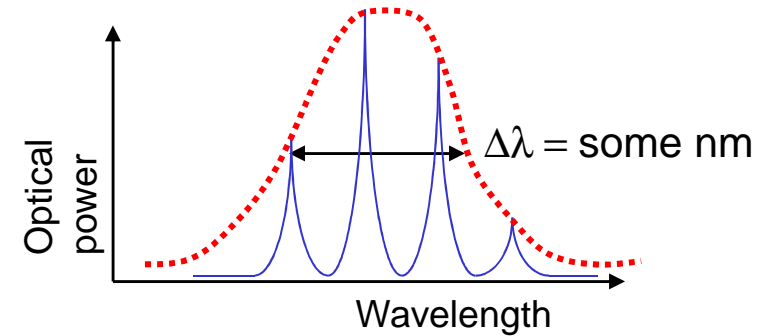
Laser diodes (5)

DFB laser diode spectrum

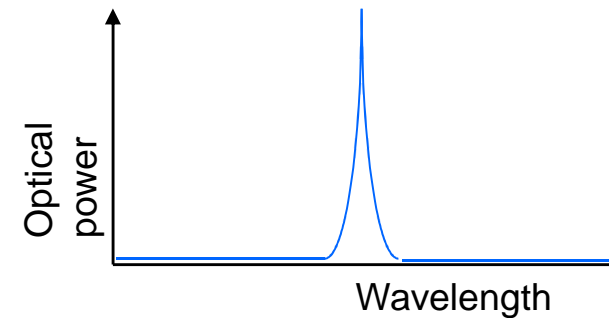


WDM
High bit rate
Long distance

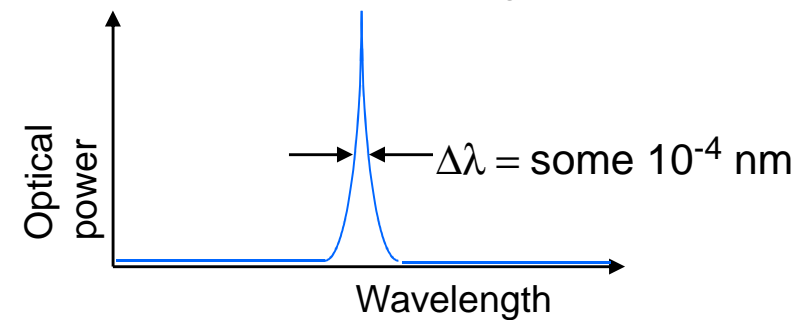
Fabry-Perot laser diode spectrum



Diffraction grating filtering

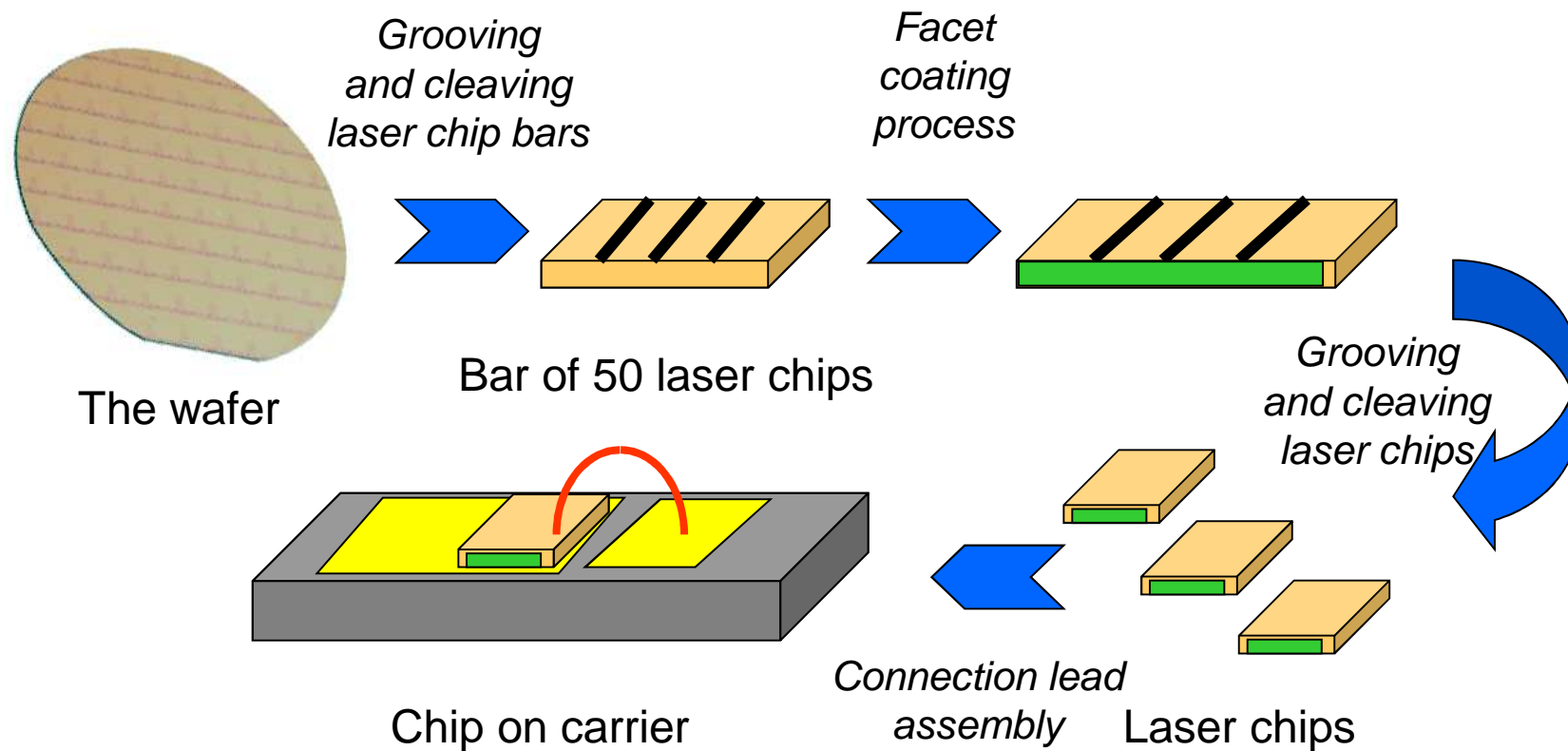


DFB laser diode spectrum



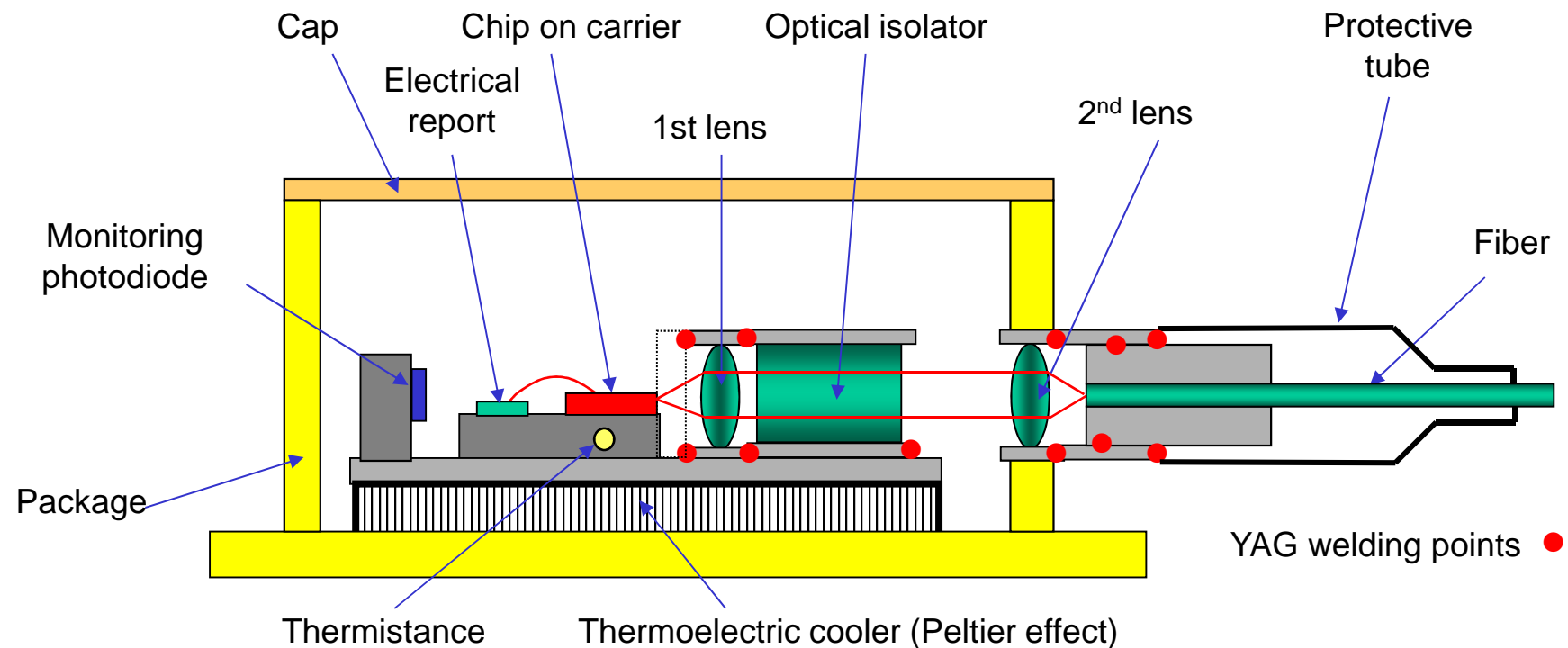
Laser diodes manufacturing

♦ From the wafer to the chip-on-carrier (COC)



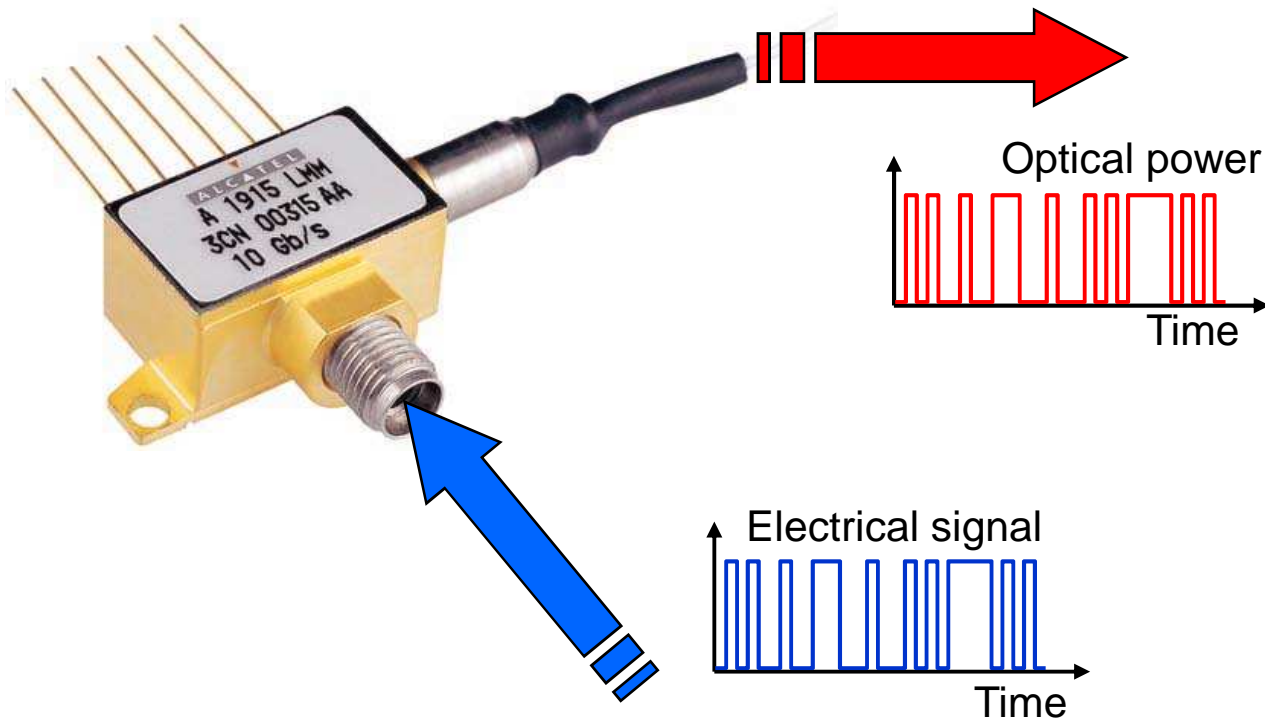
Laser diodes packaging

♦ Packaging of a transmitter module with an optical isolator



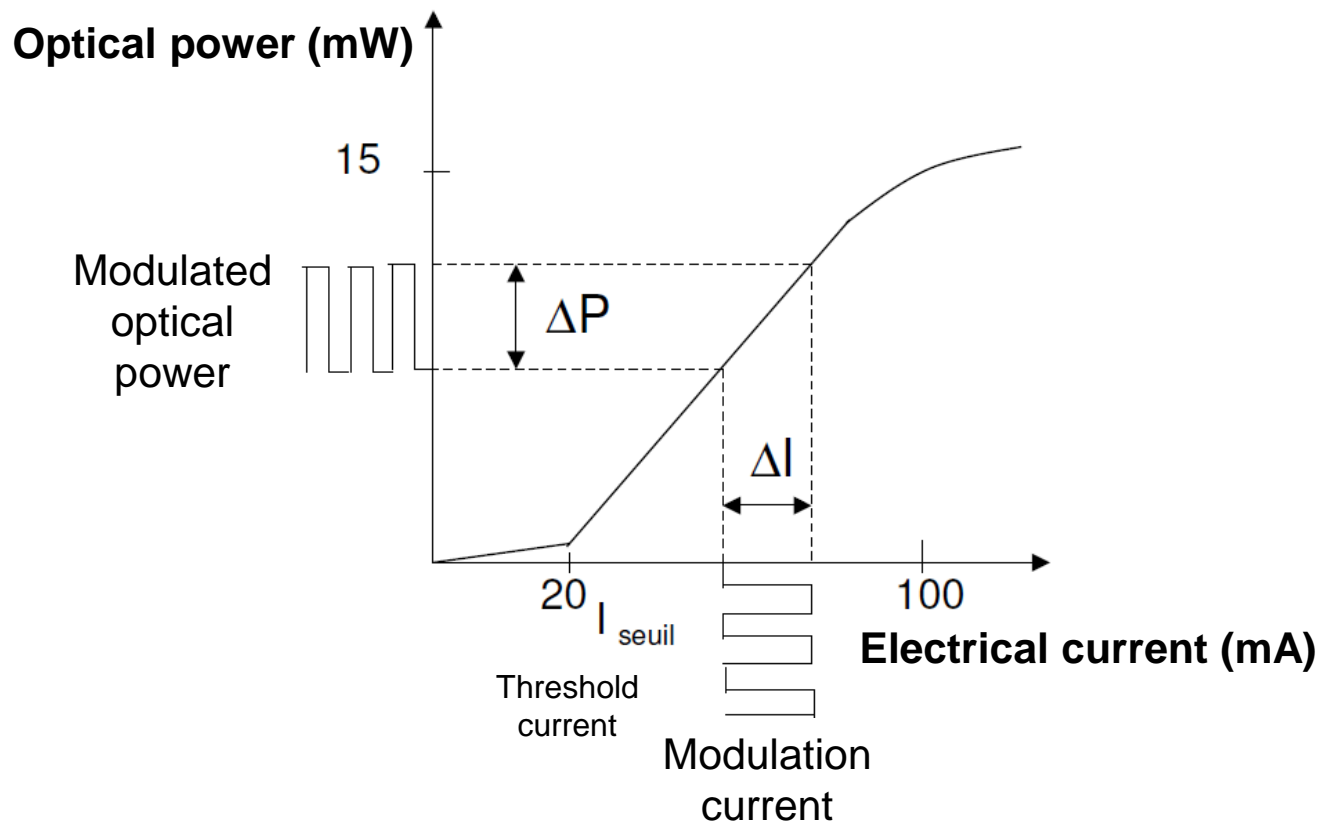
Laser diode modulation

- ♦ **Modulating an optical source**
 - Transforming the electrical signal variation into an optical power variation



Transfer characteristics of a laser diode

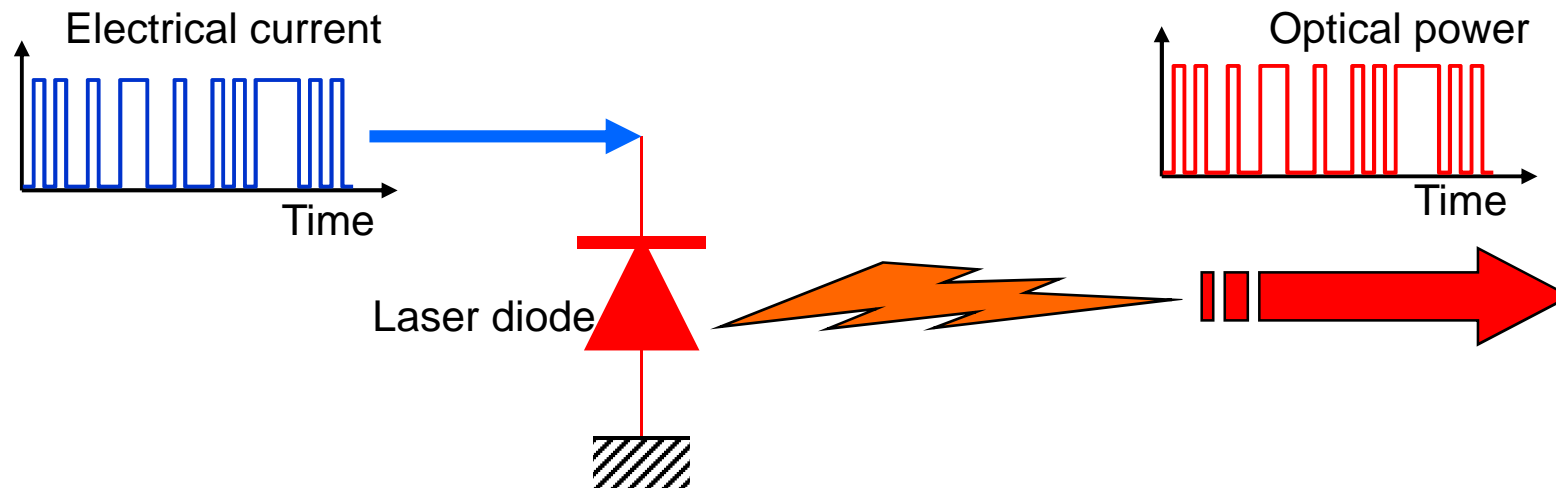
♦ Optical power vs electrical current characteristics of a laser diode



Direct modulation of a laser diode

◆ Direct modulation (1)

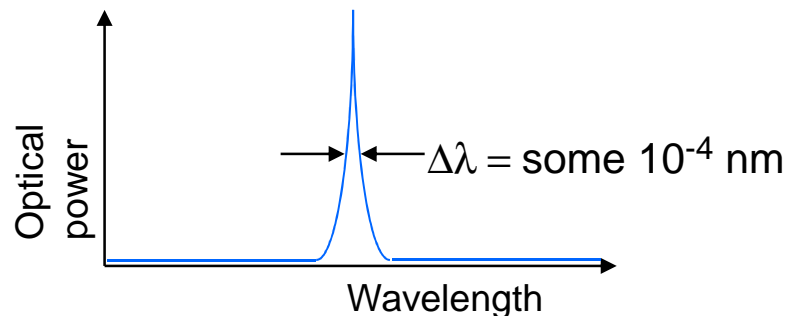
- The laser diode is directly modulated by an electrical current (injection current)



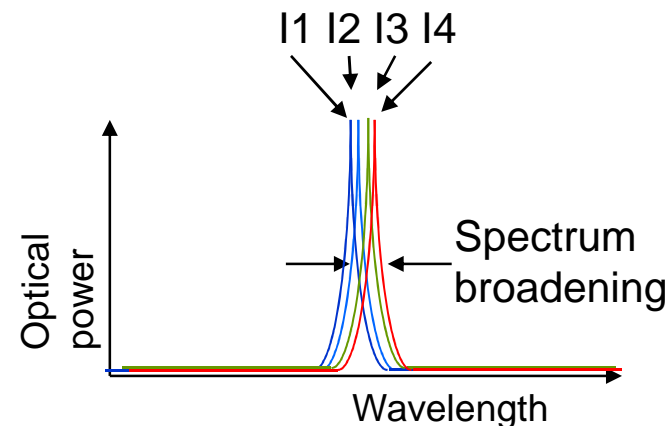
Direct modulation of a laser diode

◆ Direct modulation (2)

- Main problem inherent to direct modulation : the **chirp**
- It is the optical frequency variation due to injection current modulation
- The chirp induces laser diode spectrum broadening, which limits transmission distance due to a higher chromatic dispersion of the fiber



Constant modulating current
= CW spectrum => No chirp

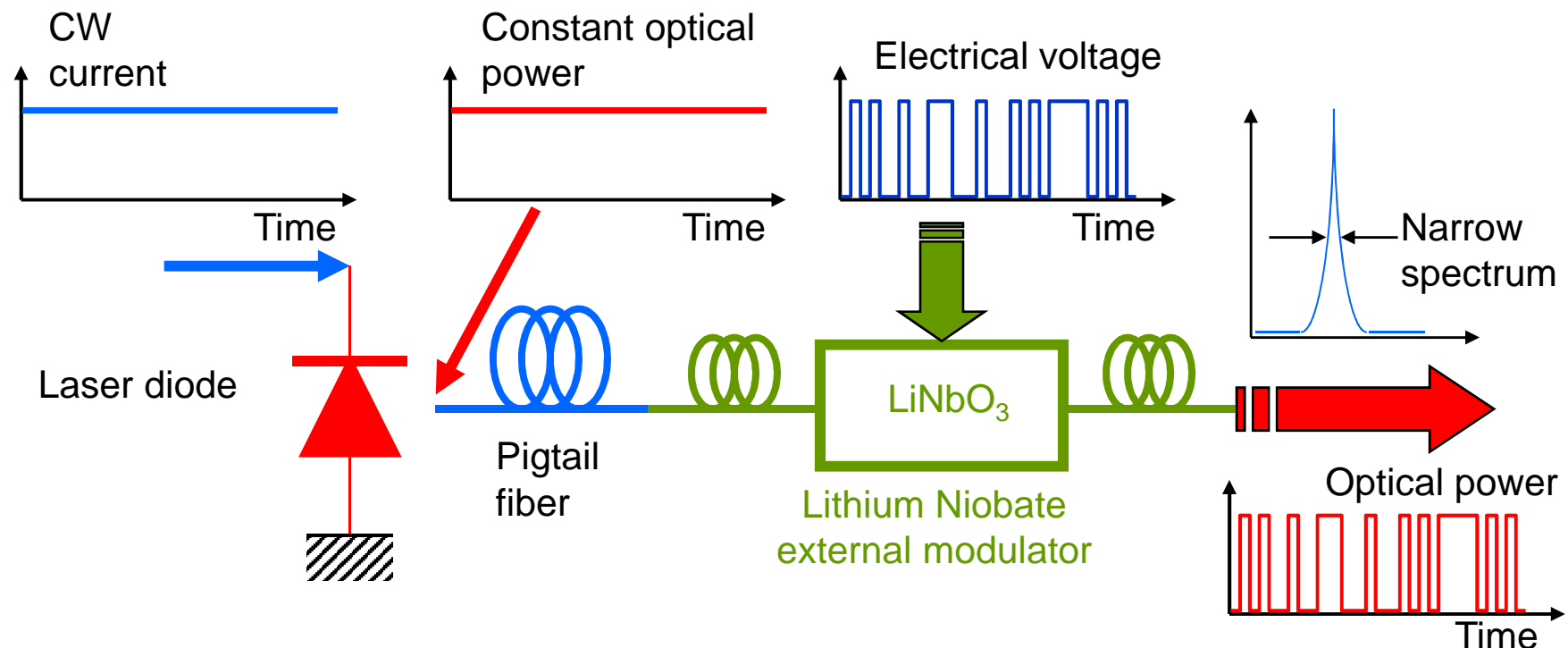


Direct modulation = current variation
Spectrum broadening due to chirp

External modulation of a laser diode

◆ External modulation (1)

- Modulation method to avoid laser diode chirp
- Allows to significantly increase transmission distance



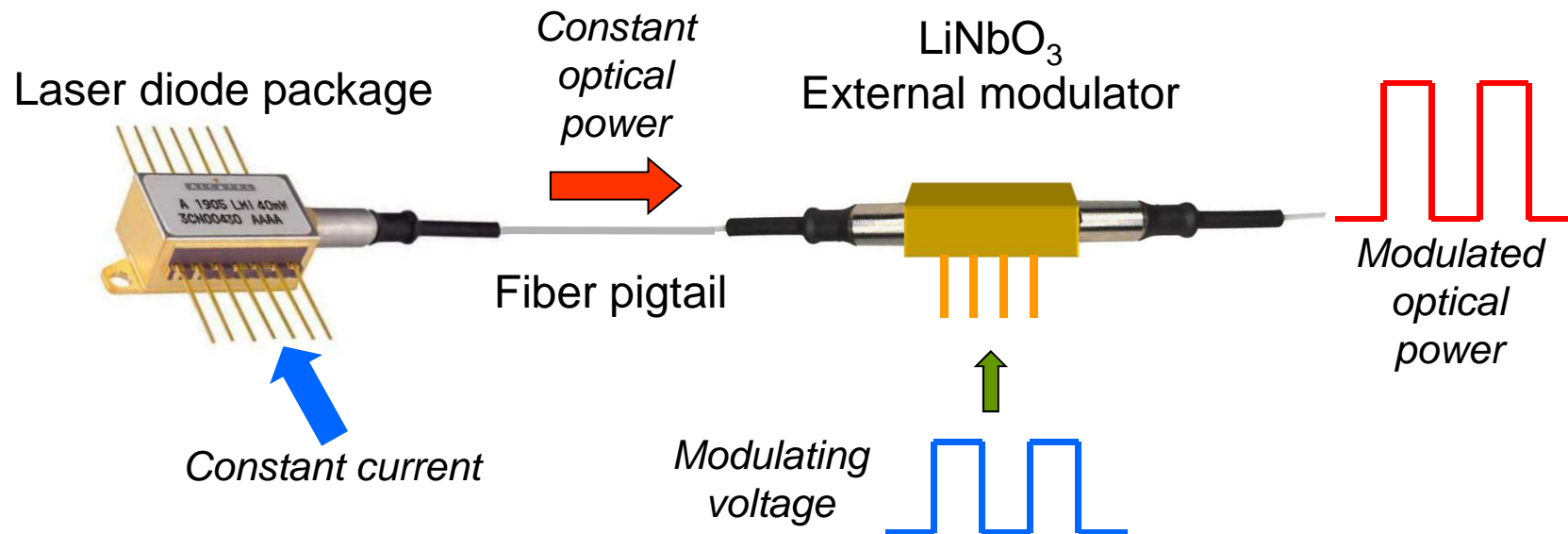
External modulation of a laser diode

♦ External modulation (2)

• Two technologies of external modulation

1. Use of an external modulator device separated from the laser diode (as Lithium Niobate modulator)

- The laser diode is not directly modulated and provides a constant optical power entering the external modulator



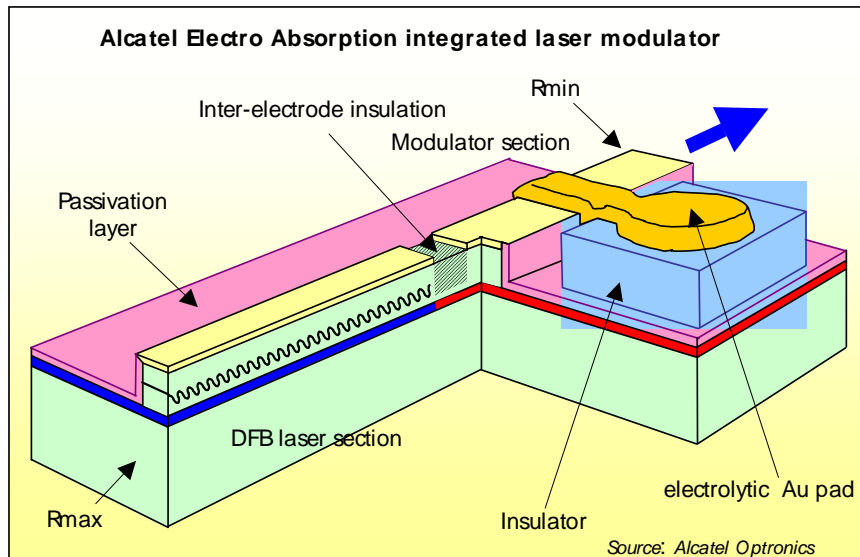
External modulation of a laser diode

♦ External modulation (3)

• Monolithic integration technology

2. Monolithic integration of the laser diode and the external modulator on the same substrate

- The external modulator is usually an Electro-Absorption (EA) modulator
- Its absorption coefficient is depending on the modulation voltage
- This kind of modulator shows a low chirp limiting transmission distance

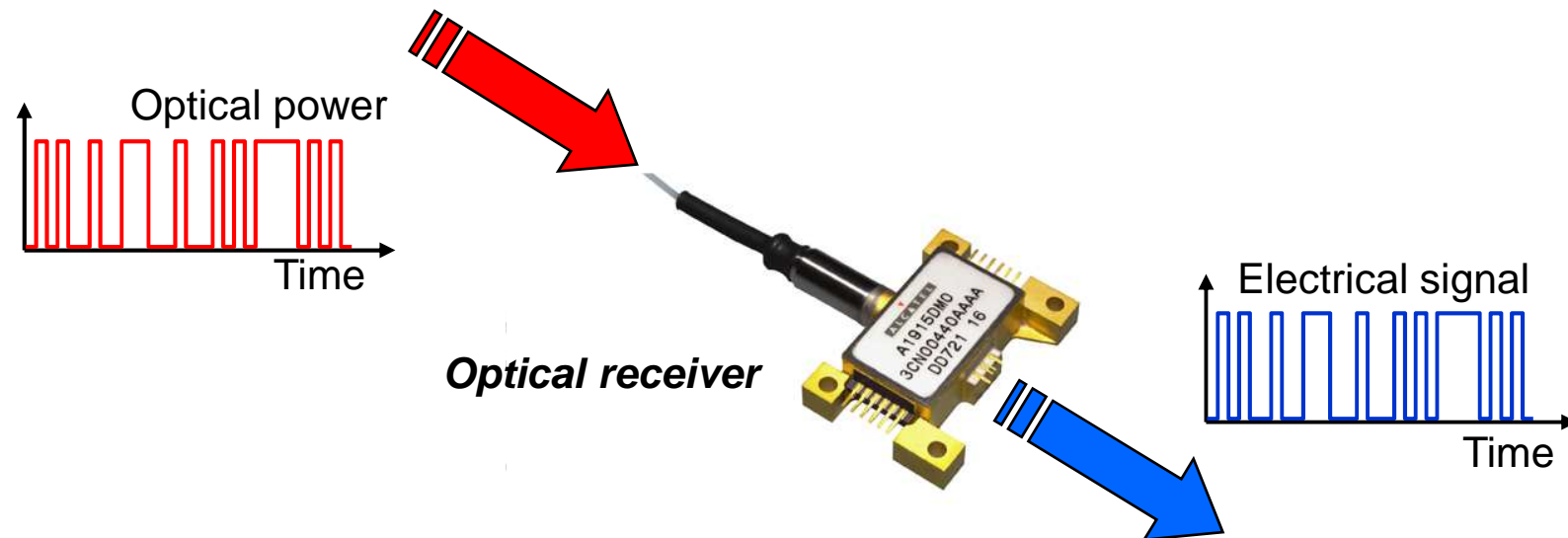


Comparison of laser diode modulations

- ♦ **Comparison of the three technologies**
 - **Direct modulation by the injection current :**
 - Used for bit rates up to 2.5 Gbit/s
 - Maximum transmission distance : 90 km (1800 ps/nm source)
 - **External modulation with separated laser diode and LiNbO₃ external modulator :**
 - Use for very high bit rates up to 40 Gbit/s
 - Almost illimited transmission distance (transoceanic systems)
 - **Integrated laser-modulator (ILM) :**
 - Used for medium bit rates (2.5 Gbit/s or 10 Gbit/s)
 - Transmission distance limited by the proper chirp of the EA modulator
 - ♦ At 2.5 Gbit/s : from 360 km (7200 ps/nm) to 640 km (12800 ps/nm)
 - ♦ At 10 Gbit/s : from 40 km (800 ps/nm) to 80 km (1600 ps/nm)

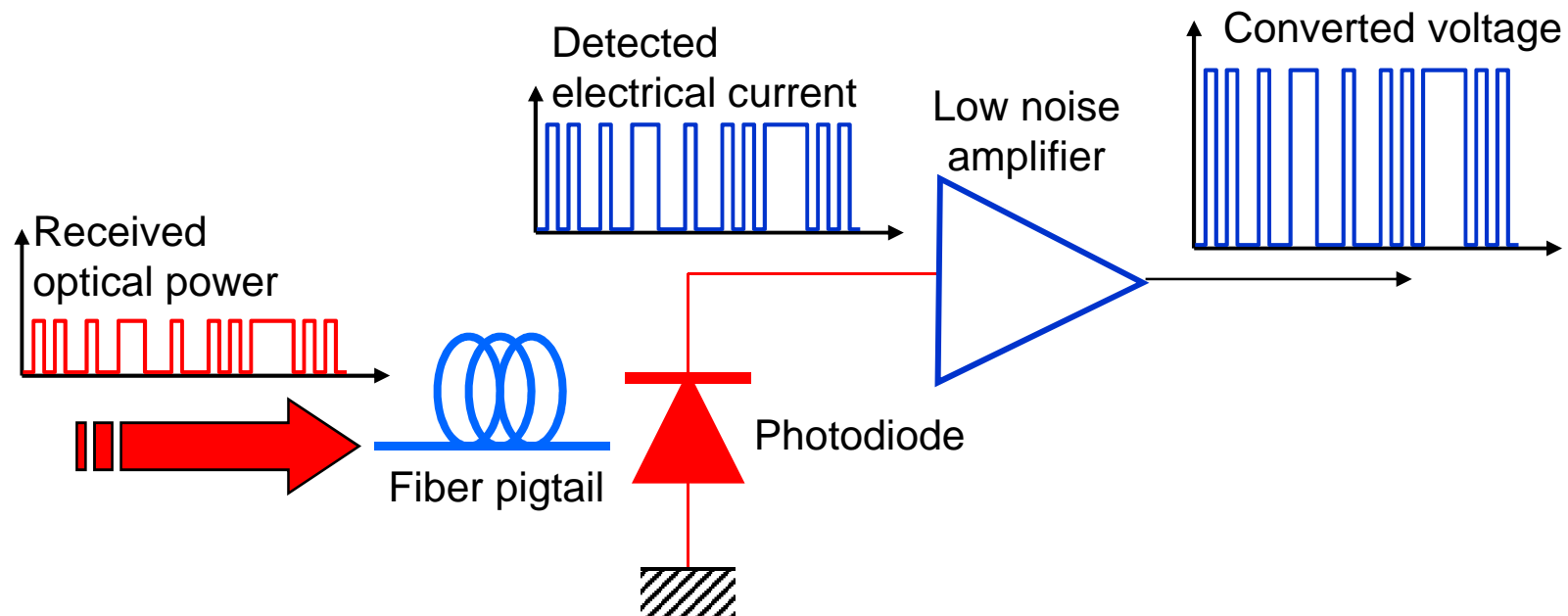
Detectors and optical receivers

- ◆ The optical receiver transforms the modulated optical power detected into a modulated electrical signal
- ◆ It consists of an optical detector (photodiode) followed by electrical circuits processing the detected signal



Optical detectors : photodiodes

- ♦ A photodiode transforms the optical power received into an electrical current (photocurrent)
- ♦ This signal is electrically amplified (low noise amplifier) and then processed. This function is realized by the optical receiver (photodiode followed by processing circuits)



Types of photodiodes

♦ Two main types of photodiodes

- **PIN photodiode (Positive-Intrinsic-Negative)**

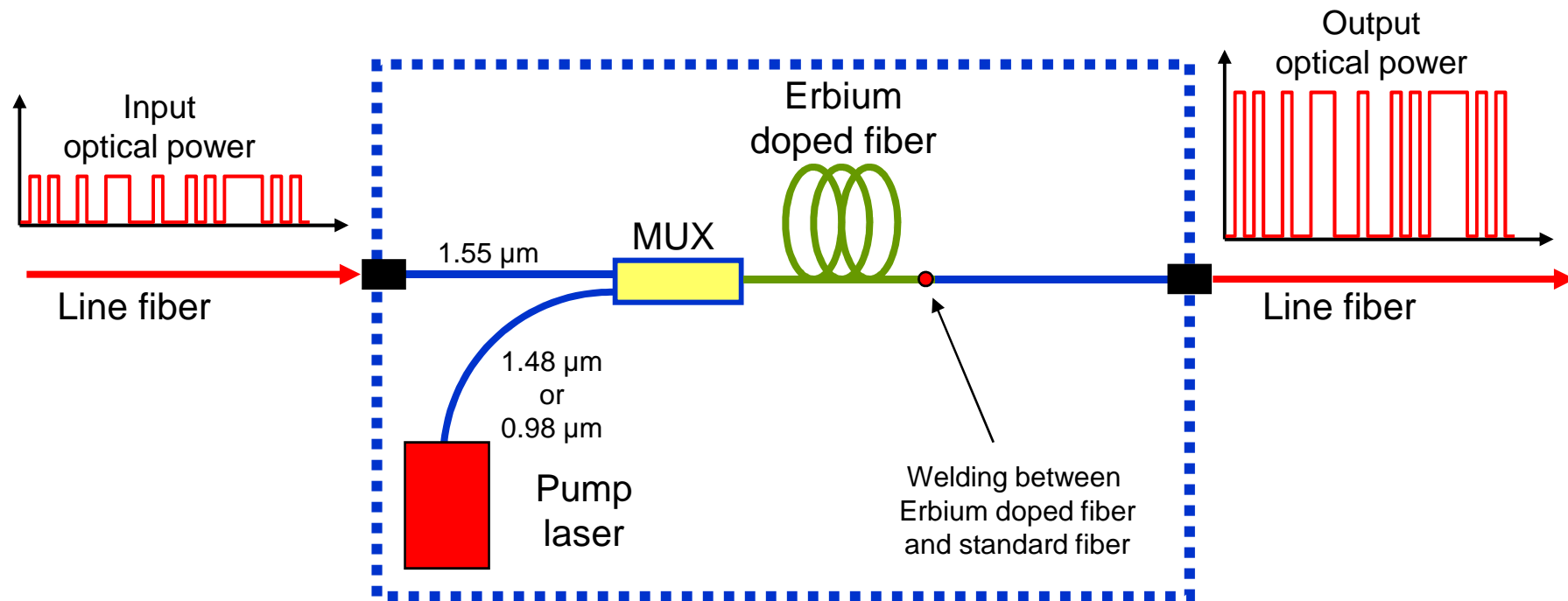
- Simple structure easy to implement
- Used for very high bit rates (up to 40 Gbit/s)

- **Avalanche photodiode (APD)**

- More complex structure
- Requires a high driving voltage
- Allows to generate a higher detected current
- Better sensitivity for detecting low levels of received optical power (long distance systems)
- Used for bit rates up to around 10 Gbit/s

Optical Fiber Amplifiers (OFA)

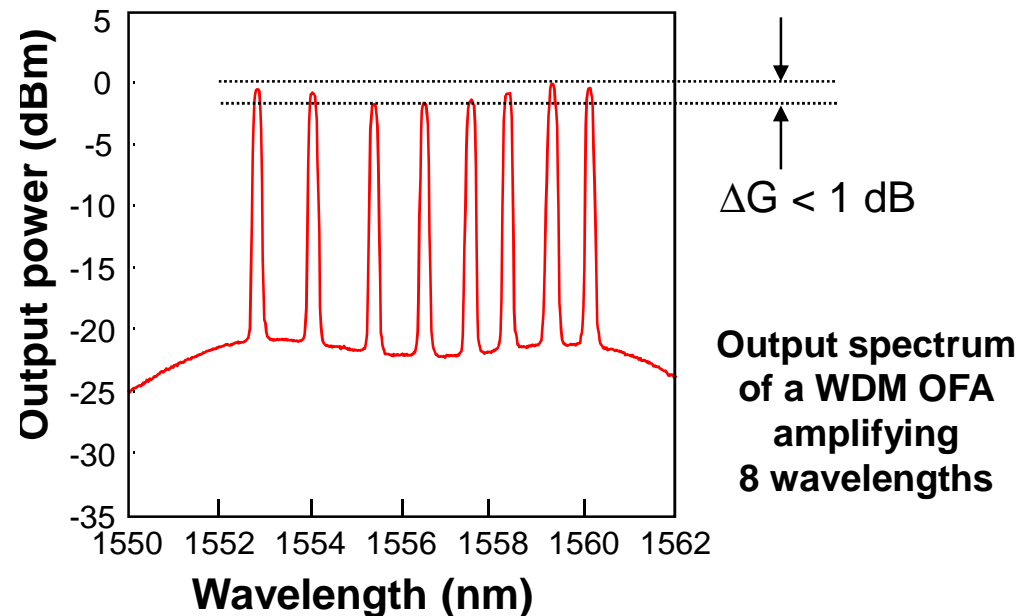
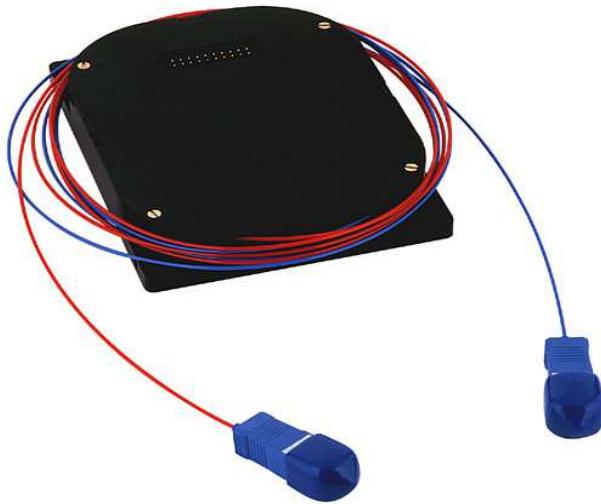
- ◆ Principle of the Erbium doped fiber amplifier (EDFA)
- ◆ Direct amplification of the optical power by energy transfer from pump wave to signal wave



OFA for WDM application

◆ Specific characteristics of WDM OFAs

- Requires a good flatness of gain spectrum
- Need for a double stage structure with mid-stage access for add-drop multiplexing (ADM) application or for inserting a dispersion compensating fiber (DCF)



Components for optical routing

- ◆ These components will be used in node equipments of future all optical networks
 - Optical routing requires basic functions as :
 - Optical switching (non-blocking switching matrices)
 - Wavelength conversion
 - These functions can be realized using the following technologies :
 - Semiconductor optical amplifier (SOA) for fast switching
 - Interferometric wavelength converter module (ICM) for wavelength conversion



SOA



ICM

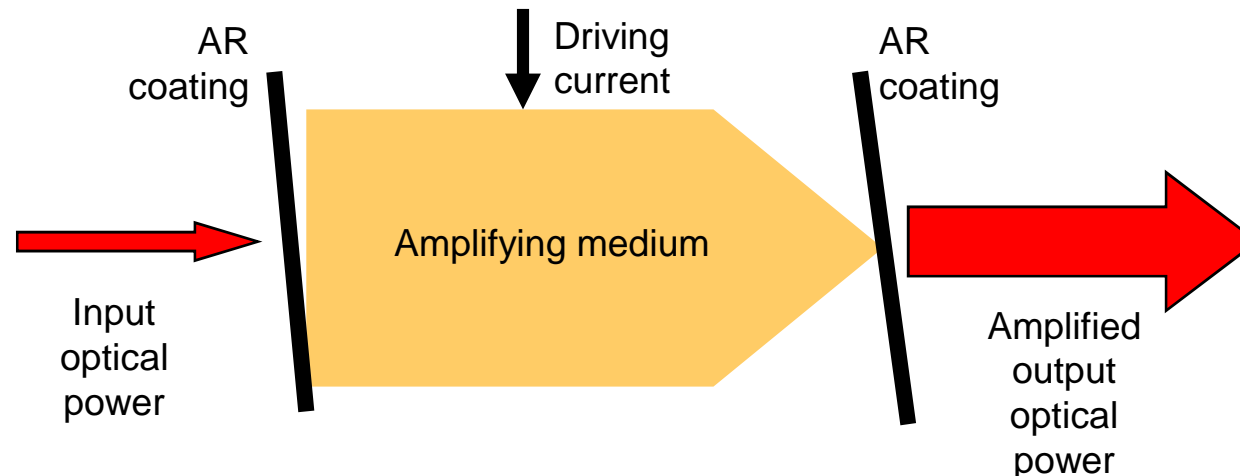
♦ SOA = Semiconductor Optical Amplifier

• Structure

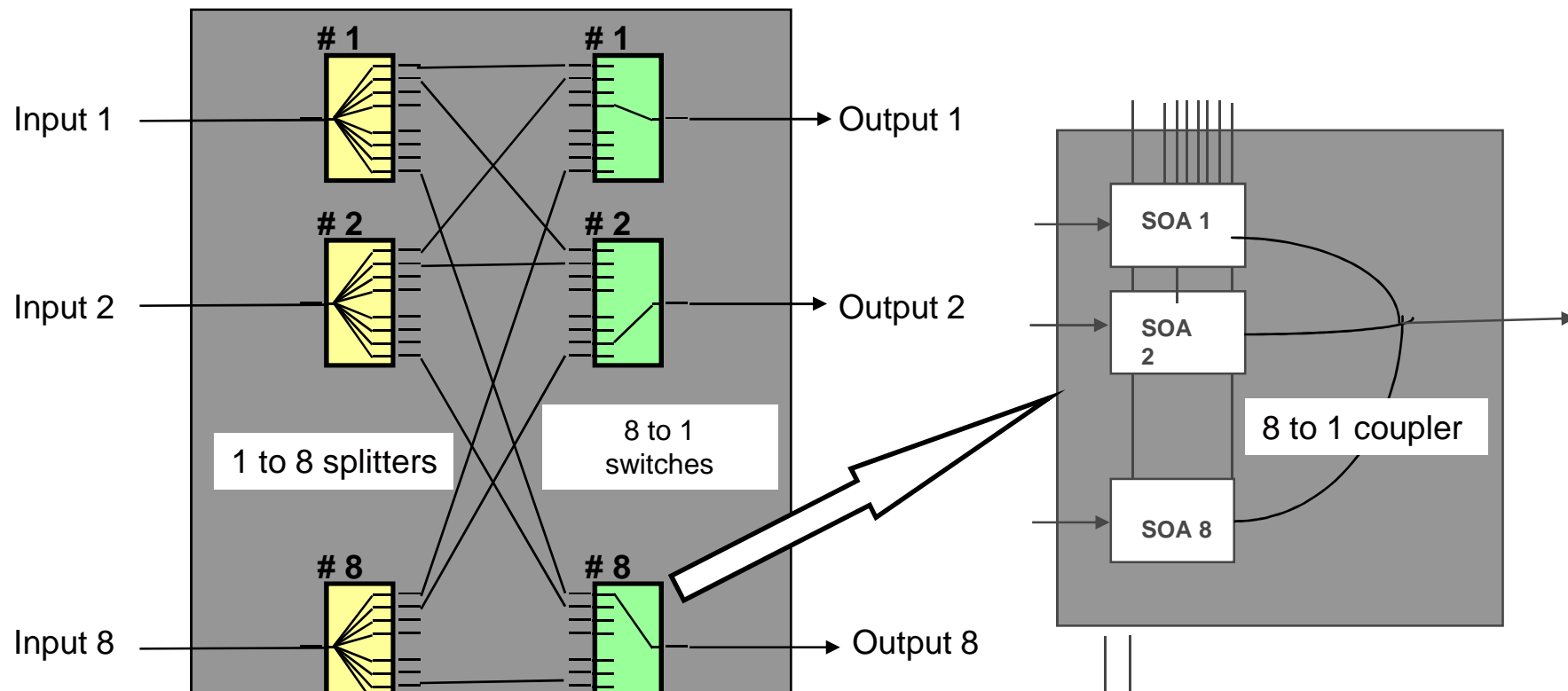
- Similar structure as for the semiconductor laser diode
- Suppression of the resonant FP cavity through anti-reflection coating and angled cleaving the two facets of the chip

• Quaternary amplifying medium : InGaAsP

- For amplification in the 1.55 μm range



Optical switching using SOA bars



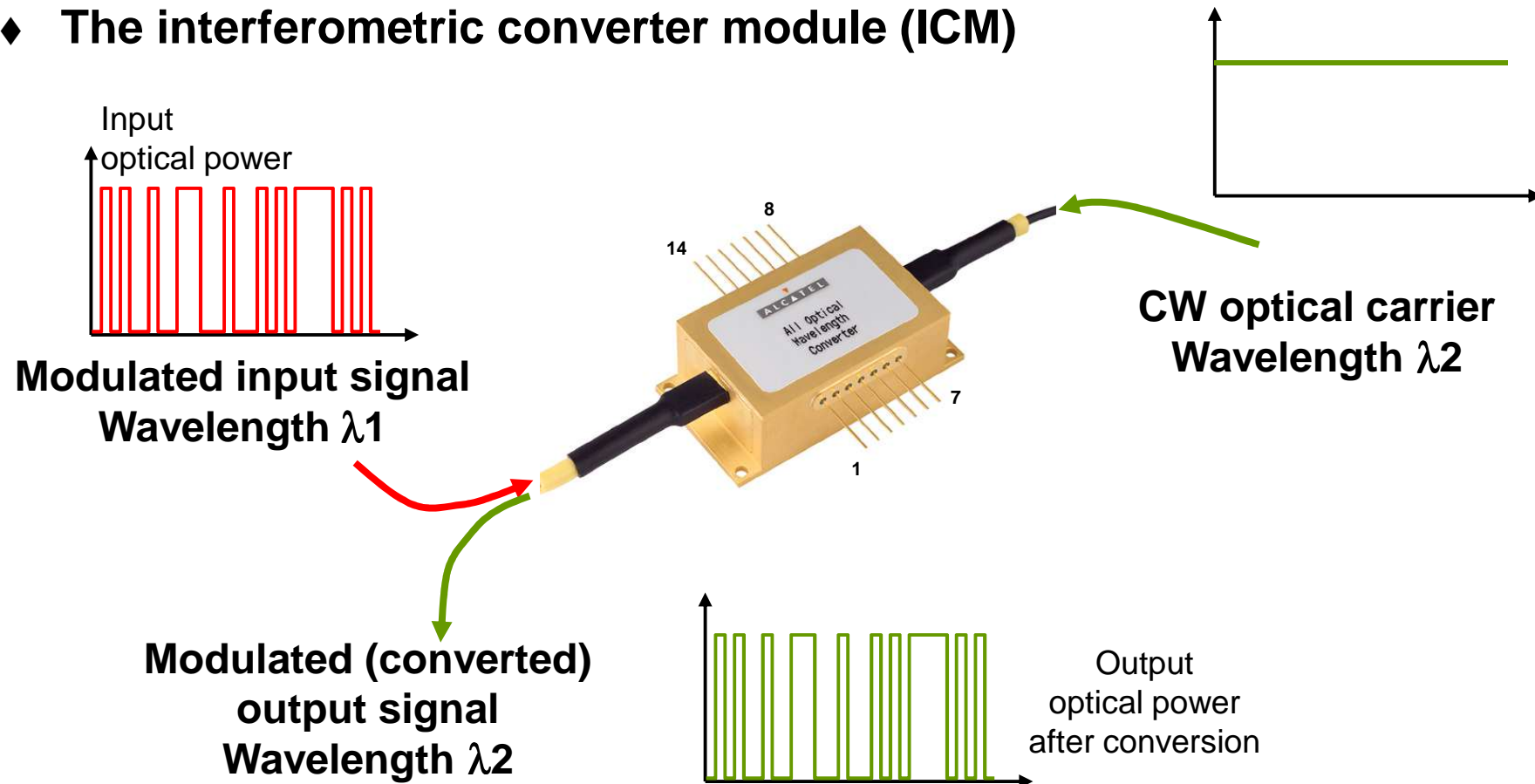
8 X 8 switching matrix
Possible extension up to 64 x 64

SOA used as an optical switch

- No switching loss due to SOA gain
- High speed switching time (some 10 ps)

Wavelength conversion

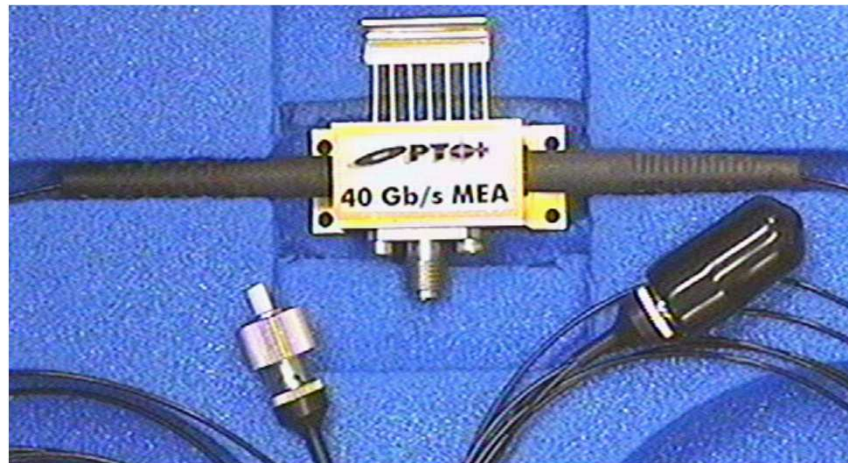
◆ The interferometric converter module (ICM)



Components for very high bit rate applications

- ◆ **Components dedicated to future 40 Gbit/s applications**
 - SDH standard : STM-256 frame
 - SONET standard : OC-768 frame
- ◆ **Electroabsorption (EA) modulator**
- ◆ **Integrated PIN-preamp receiver**
- ◆ **In the near future : integrated laser-modulator (ILM) source**

*EA modulator
for 40 Gbit/s
applications*

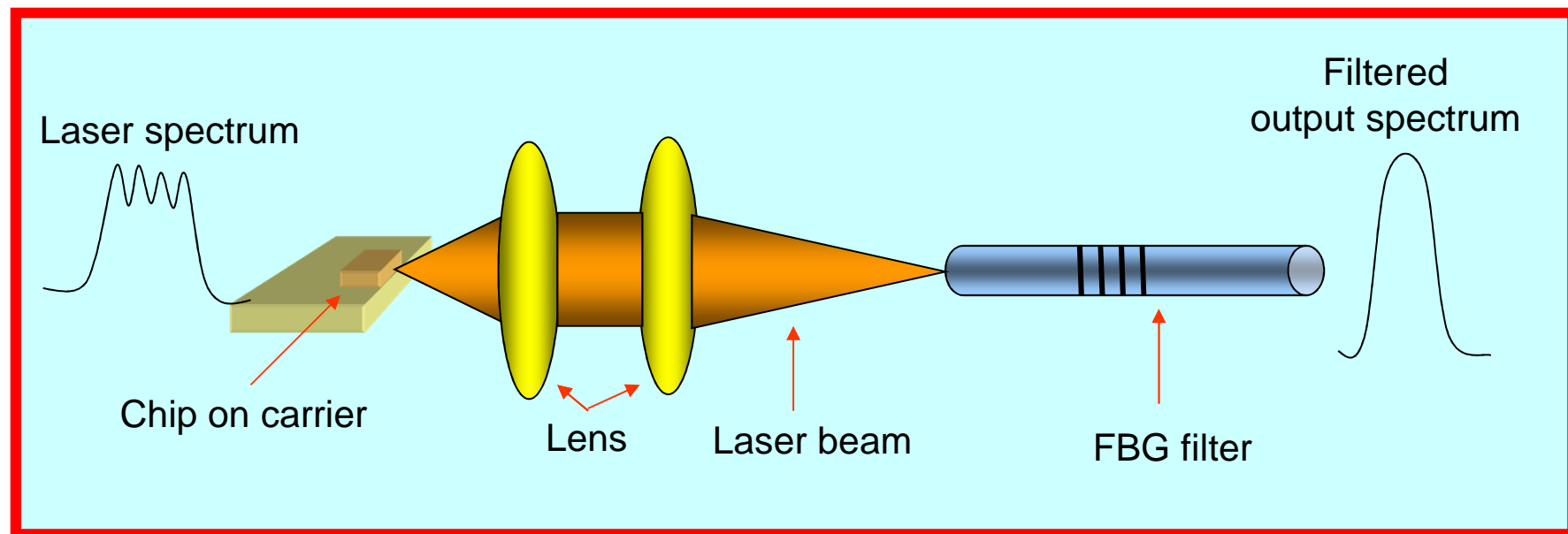


Passive components (1)

- ◆ **Passive components do not require any electrical energy for working**
- ◆ **Two specific technologies allow to realize passive components :**
 - **FBG (Fiber Bragg Grating) technology**
 - **Bragg grating made in a silica fiber**
 - **Used to realize compact optical filters**
 - ◆ Gain flattening filters for OFAs
 - ◆ Wavelength stabilizing filters for pump lasers
 - ◆ Band-pass filters for WDM application
 - **AWG (Arrayed Waveguide Grating) technology**
 - **Waveguide gratings made in silica-on-silicon platforms**
 - **Used for realizing wavelength MUX and DEMUX**

Passive components (2)

- ◆ Example of use of a FBG filter as a band-pass filter



Passive components (3)

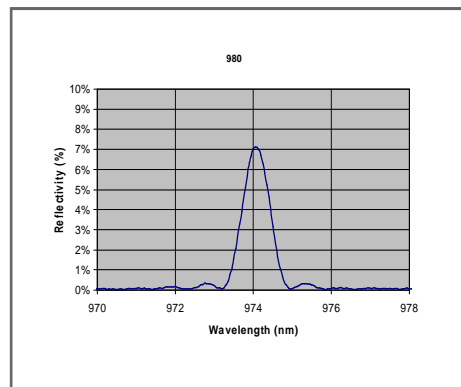
Mux/Demux

- ◆ Arrayed Waveguide Grating
- ◆ Silica on silicon based
- ◆ 16x100GHz, 40x50GHz or 40x100GHz channels
- ◆ Low input to output loss



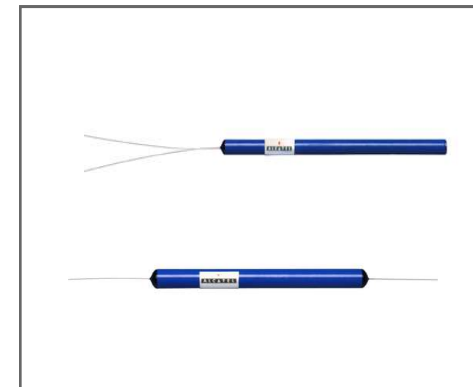
Pump stabilizer

- ◆ FBG technology
- ◆ 1480 nm or 980 nm pump



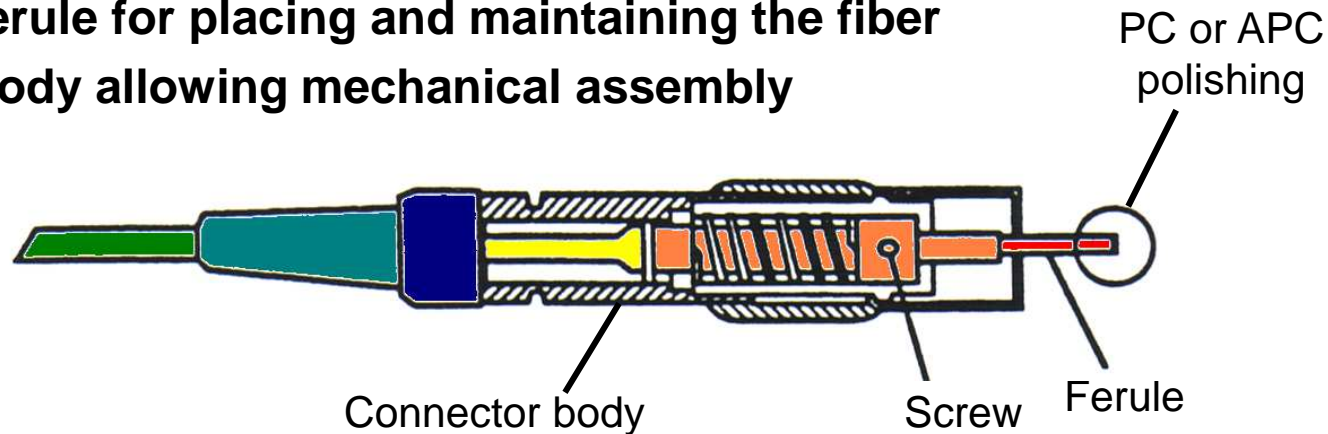
Wavelength filters

- ◆ FBG technology
- ◆ Band-pass filters
- ◆ ADM filters
- ◆ Gain flattening filters



Optical connectors (1)

- ♦ An optical connector is used for a non-permanent assembly
- ♦ It consists in two main parts :
 - A ferule for placing and maintaining the fiber
 - A body allowing mechanical assembly



- ♦ Two types of ferules
 - Defined by the quality of the optical polished surface :
 - PC (Physical Contact) : hemispheric polishing
 - APC (Angled-PC) : angled (around 7°) hemispheric polishing

♦ Main types of optical connectors

- FC (field connector) with screw and positioning key : the most common
- SC (subscriber connector) : push-pull type with plastic body
- ST (standard connector) : with positioning key
- E2000 : European connector with plastic body
- MU : push-pull type miniature connector
- LC (low cost) : small connector with plastic body

♦ Main characteristics

- Insertion loss (or assembly loss) : < 0.5 dB
- Return loss (or reflection loss) : < -50 dB (PC), < -60 dB (APC)

Main types of optical connectors

